## MITSUBISHI RF POWER TRANSISTOR **2SC2904**

#### NPN EPITAXIAL PLANAR TYPE

#### DISCRIPTION

2SC2904 is a silicon NPN epitaxial planar type transistor specifically designed for high power amplifiers in HF band.

#### **FEATURES**

High gain: Gpe ≥ 11.5dB

 $@V_{CC} = 12.5V, P_0 = 100W, f = 30MHz$ 

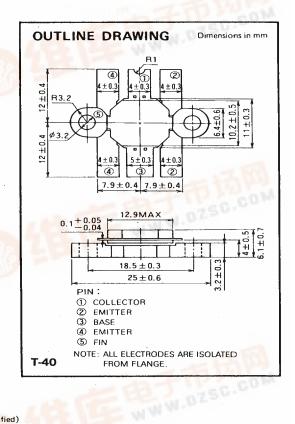
High ruggedness: Ability to withstand 20:1 load VSWR when operated at f = 30MHz

 $P_0 = 100W, V_{CC} = 15.2V$ Emitter ballansted construction

Low thermal resistance ceramic package with flange.

#### **APPLICATION**

Output stage of transmitter in HF band SSB mobile radio sets.



### ABSOLUTE MAXIMUM RATINGS (T<sub>C</sub>=25°C unless otherwise specified)

Symbol	Parameter	Conditions	Ratings	Unit
Vcво	Collector to base voltage		50	V
VEBO	Emitter to base voltage	Part of the second	5	V
VCEO	Collector to emitter voltage	R <sub>BE</sub> = ∞	20	V
I <sub>C</sub>	Collector current		22	А
Pc	Collector dissipation	Ta = 25°C	7.8	w
		T <sub>C</sub> =25°C	200	W
Ti	Junction temperature		175	°C
Tstg	Storage temperature		-55 to 175	°C
Rth-c	Thermal resistance		0.75	°C/W

Note. Above parameters are guaranteed independently.

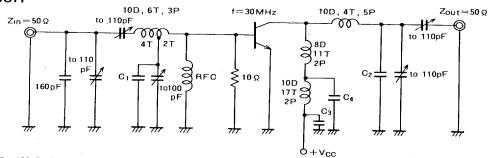
### **ELECTRICAL CHARACTERISTICS** (T<sub>C</sub> = 25°C unless otherwise specified)

Symbol	Parameter		Limits			
		Test conditions	Min	Тур	Max	Unit
V(BR)EBO	Emitter to base breakdown voltage	I <sub>E</sub> =20mA, I <sub>C</sub> =0	5			٧
V(BR)CBO	Collector to base breakdown voltage	$I_C = 20 \text{mA}, I_E = 0$	50			V
V(BR)CEO	Collector to emitter breakdown voltage	I <sub>C</sub> =100 mA, R <sub>BE</sub> =∞	20			V
СВО	Collector cutoff current	V <sub>GB</sub> =15V, I <sub>E</sub> =0			5	mΑ
I <sub>EBO</sub>	Emitter cutoff current	V <sub>EB</sub> =3V, I <sub>C</sub> =0			5	mA
hFE	DC forward current gain*	V <sub>CE</sub> =10V, I <sub>C</sub> =1A	10	50	180	
Po	Output power	f=30MHz, V <sub>CC</sub> =12.5V, P <sub>in</sub> =7W	100	110		w
$\eta_{\rm C}$	Collector efficiency		55	60		%

\*Pulse test,  $P_W = 150 \mu s$ , duty=5%. Above parameters, ratings, limits and conditions are subject to change.



#### **TEST CIRCUIT**



- C1: 160pF, 160pF, 82pF in parallel
- C<sub>2</sub>: 82pF, 82pF, 82pF in parallel

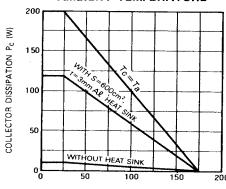
- C<sub>2</sub>: 82pF, 82pF, 82pF in parallel C<sub>3</sub>: 100pF, 4700pF, 4700pF, 0.22 $\mu$ F, 0.22 $\mu$ F, 0.22 $\mu$ F, 330 $\mu$ F in parallel C<sub>4</sub>: 100pF, 220pF, 4700pF, 0.1 $\mu$ F, 330 $\mu$ F in parallel NOTES: All coils but L<sub>1</sub> are made from 1.5 $\phi$ mm silver plated copper wire, L<sub>1</sub> is made from 2.3 $\phi$ mm copper wire. P: Pitch of coil

COLLECTOR CURRENT Ic (A)

- D: Inner diameter of coil
- T: Turn number of coil
- Dimension is milli-meter

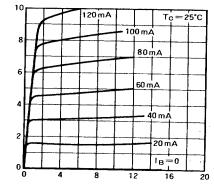
#### TYPICAL PERFORMANCE DATE

#### COLLECTOR DISSIPATION VS. **AMBIENT TEMPERATURE**



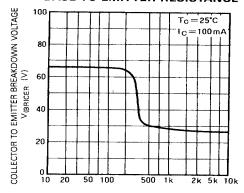
AMBIENT TEMPERATURE Ta (°C)

#### COLLECTOR CURRENT VS. COLLECTOR TO EMITTER VOLTAGE



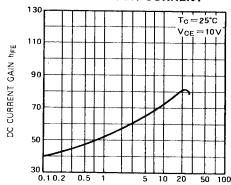
COLLECTOR TO EMITTER VOLTAGE VCE (V)

#### **COLLECTOR TO EMITTER BREAKDOWN VOLTAGE VS. BASE TO EMITTER RESISTANCE**



BASE TO EMITTER RESISTANCE RBE (Q)

#### DC CURRENT GAIN VS. **COLLECTOR CURRENT**

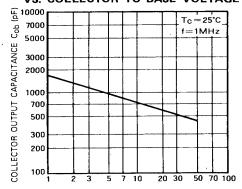


COLLECTOR CURRENT Ic (A)

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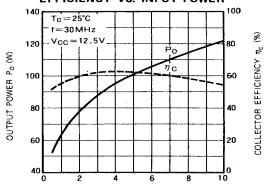
#### NPN EPITAXIAL PLANAR TYPE

# COLLECTOR OUTPUT CAPACITANCE VS. COLLECTOR TO BASE VOLTAGE



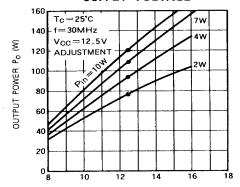
COLLECTOR TO BASE VOLTAGE VCB (V)

# OUTPUT POWER, COLLECTOR EFFICIENCY VS. INPUT POWER



INPUT POWER Pin (W)

## OUTPUT POWER VS. COLLECTOR SUPPLY VOLTAGE



COLLECTOR SUPPLY VOLTAGE Vcc (V)